



DMTH10H1M7STLWQ

100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI1012-8 (TOLL)

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Tc = +25°C	
100V	2mΩ @ V _{GS} = 10V	250A	

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Motor Control
- DC-DC Converters
- Power Management

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H1M7STLWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

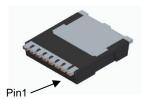
Mechanical Data

- Case: POWERDI[®]1012-8 (TOLL)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.388 grams (Approximate)

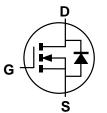
POWERDI1012-8



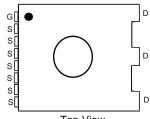




Bottom View



Internal Schematic



Top View Pin Configuration

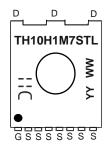
Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH10H1M7STLWQ-13	POWERDI1012-8	1,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



POWERDI1012-8

⊃¦¦= Manufacturer's Marking
 TH10H1M7STL = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 21 = 2021)
 WW = Week Code (01 to 53)

POWERDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	100	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$		lo	250 176	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	1000	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	250	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		Ism	1000	Α
Avalanche Current, L = 0.3mH	las	73	Α	
Avalanche Energy, L = 0.3mH	Eas	799.4	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	6	W
Thermal Resistance, Junction to Ambient (Note 5)		RθJA	24	°C/W
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		PD	250	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	0.6	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

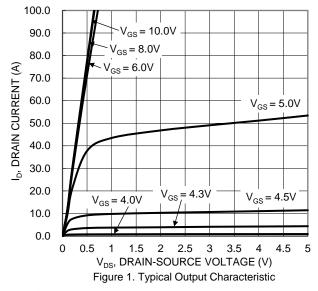
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS} (TH)	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.4	2	mΩ	$V_{GS} = 10V, I_D = 30A$	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 30A	
DYNAMIC CHARACTERISTICS (Note 8)	DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	9871			V _{DS} = 50V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	3019		pF		
Reverse Transfer Capacitance	Crss	_	58				
Gate Resistance	R_g	_	2.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	147	_		V 50V I 00A	
Gate-Source Charge	Qgs	_	43	_	nC	V _{DD} = 50V, I _D = 30A, V _{GS} = 10V	
Gate-Drain Charge	Q_{gd}	_	32	_		VGS = 10V	
Turn-On Delay Time	td(ON)	_	29	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 30A, R_{G} = 4.7\Omega$	
Turn-On Rise Time	t _R	_	64	_	ns		
Turn-Off Delay Time	tD(OFF)	_	108	_	115		
Turn-Off Fall Time	tF	_	69	_			
Reverse Recovery Time	t _{RR}	_	91	_	ns I of a live 400 A /		
Reverse Recovery Charge	Qrr	_	270	_	nC	IF = 25A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:







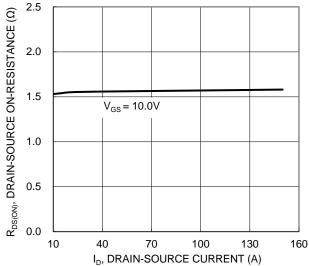


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

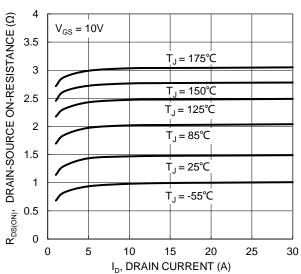
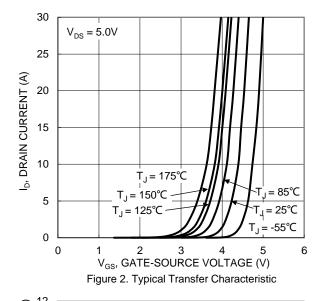
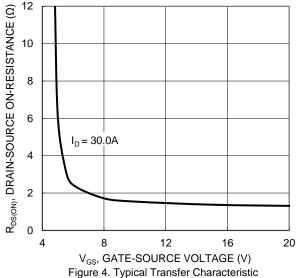


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





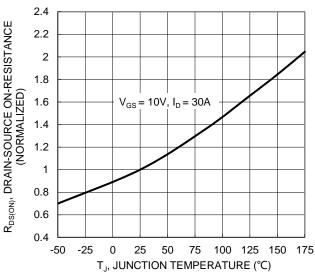


Figure 6. On-Resistance Variation with Temperature





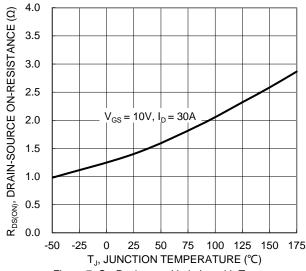
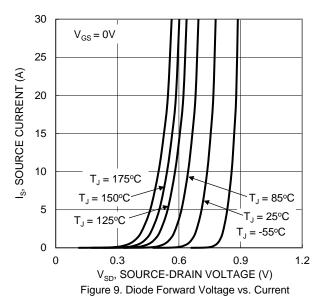
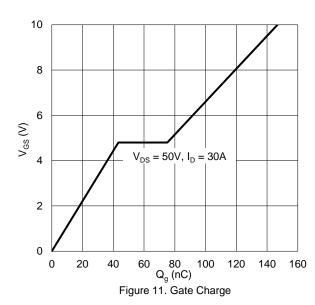


Figure 7. On-Resistance Variation with Temperature





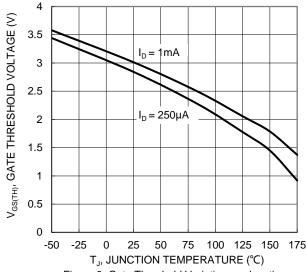


Figure 8. Gate Threshold Variation vs. Junction Temperature

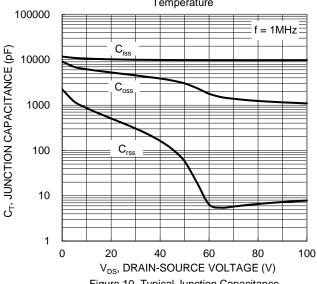
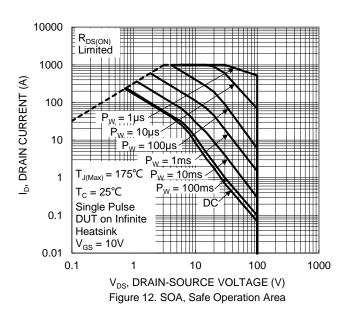


Figure 10. Typical Junction Capacitance





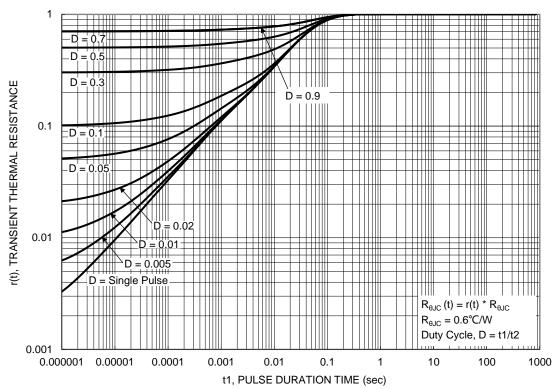


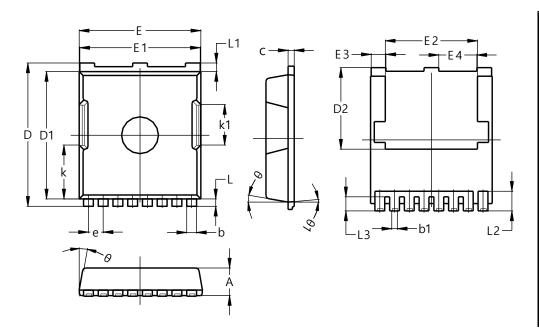
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI1012-8

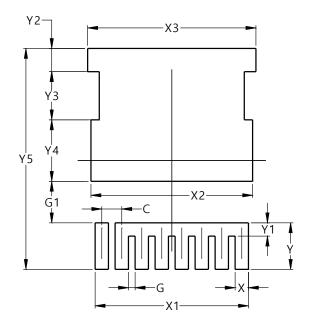


DOWEDDIAGO					
POWERDI1012-8					
Dim	Min	Max	Тур		
Α	2.20	2.40	2.30		
b	0.70	0.90	0.80		
b1	0.42	0.50	0.45		
C	0.40	0.60	0.50		
D	11.48	11.88	11.68		
D1	10.23	10.53	10.38		
D2	6.45	6.85	6.65		
Е	9.70	10.10	9.90		
E1	9.70	9.90	9.80		
E2	7.00	8.00	7.50		
E3	1.10	1.30	1.20		
E4	3.00	3.20	3.10		
е	1.20 BSC				
k	4.39 REF				
k1	,	3.30 REF	•		
L	0.50	0.70	0.60		
L1	0.50	0.90	0.70		
L2	1.40	1.80	1.60		
L3	1.00	1.30	1.15		
θ	00	15º	10°		
θ1	00	10°	5°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI1012-8



Dimensions	Value (in mm)			
С	1.200			
G	0.400			
G1	2.500			
Х	0.800			
X1	9.200			
X2	9.700			
Х3	10.100			
Υ	2.800			
Y1	0.800			
Y2	1.400			
Y3	2.900			
Y4	3.700			
Y5	13.300			



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